3.5 x2.8mm SMD CHIP LED LAMP

Part Number: KPED-3528CGCK Green

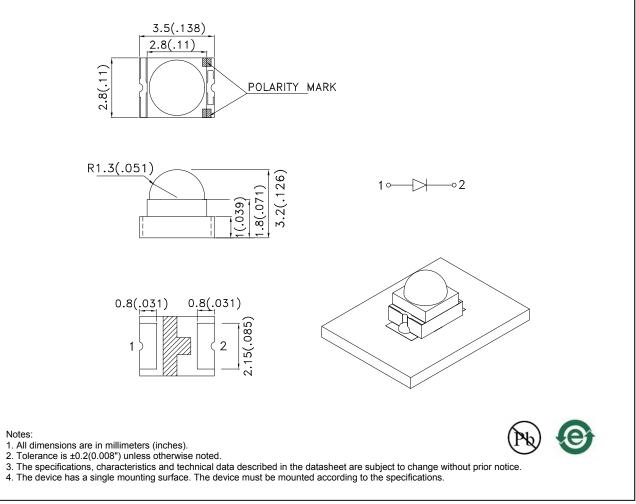
Features

- Single color.
- Suitable for all SMT assembly and solder process.
- Ideal for backlighting.
- Available on tape and reel.
- Package: 500pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

Description

The Green source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode.

Package Dimensions



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Selection Guide

Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]		
			Min.	Тур.	201/2		
KPED-3528CGCK	Green (AlGaInP)	Water Clear	80	120	40°		

Notes:

θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
Luminous intensity/ luminous Flux: +/-15%.
Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions	
λpeak	Peak Wavelength	Green	574		nm	I⊧=20mA	
λD [1]	Dominant Wavelength	Green	570		nm	I⊧=20mA	
Δλ1/2	Spectral Line Half-width	Green	20		nm	I⊧=20mA	
С	Capacitance	Green	15		pF	VF=0V;f=1MHz	
Vf [2]	Forward Voltage	Green	2.1	2.5	V	l⊧=20mA	
IR	Reverse Current	Green		10	uA	VR=5V	

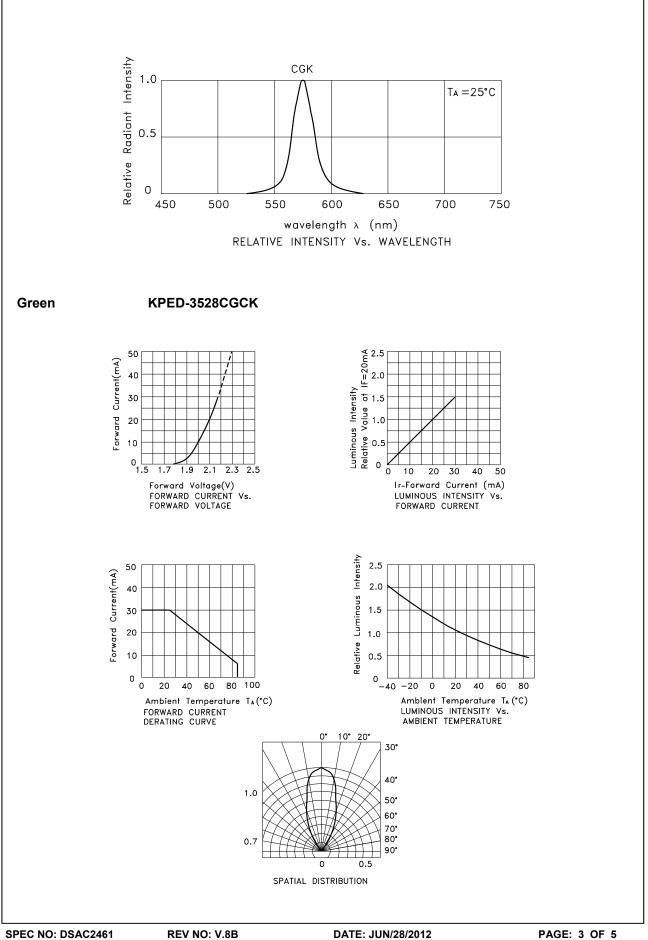
Notes: 1.Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V. 3. Wavelength value is traceable to the CIE127-2007 compliant national standards.

Absolute Maximum Ratings at TA=25°C

Parameter	Green	Units	
Power dissipation	75	mW	
DC Forward Current	30	mA	
Peak Forward Current [1]	150	mA	
Reverse Voltage	5	V	
Operating Temperature	-40°C To +85°C		
Storage Temperature	-40°C To +85°C		

Note:

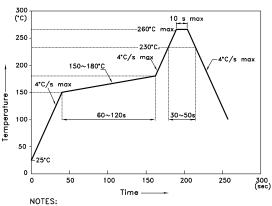
1. 1/10 Duty Cycle, 0.1ms Pulse Width.



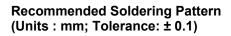
KPED-3528CGCK

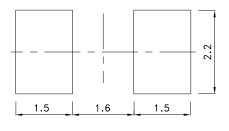
Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

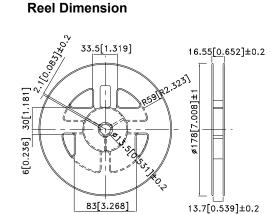
Reflow Soldering Profile For Lead-free SMT Process.

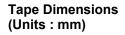


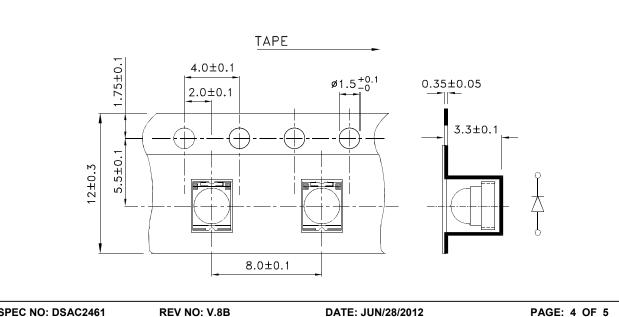
NOTES: 1.We recommend the reflow temperature 245°C(+/-5°C).The maximum soldering temperature should be limited to 260°C. 2.Don't cause stress to the epoxy resin while it is exposed to high temperature. 3.Number of reflow process shall be 2 times or less.







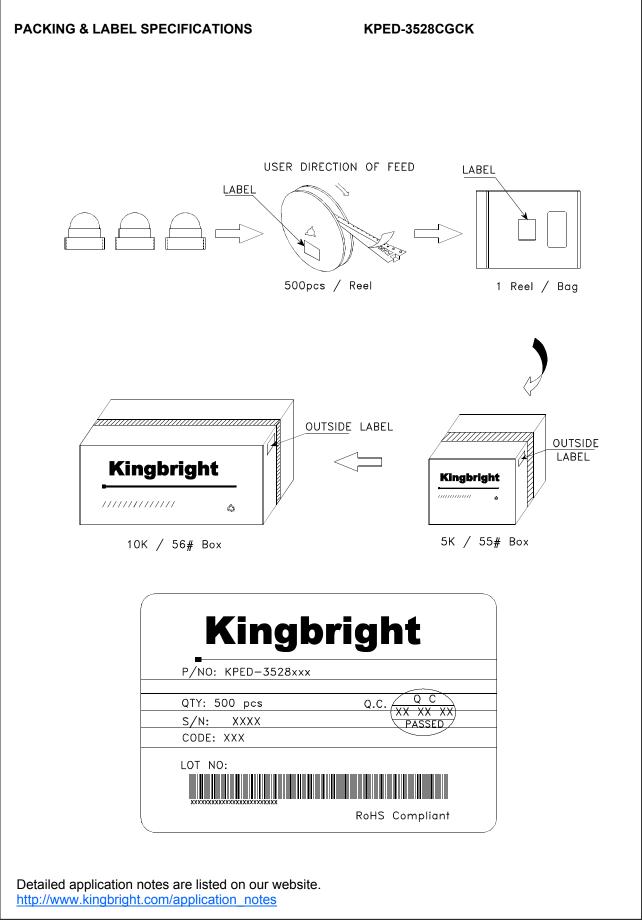




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